

L Number	Hits	Search Text	DB	Time stamp
1	46773	mounting adj structure	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/19 16:04
2	30	(mounting adj structure) and optoelectronic adj component\$1	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/19 16:18
3	1	((mounting adj structure) and optoelectronic adj component\$1) and rhomb\$3	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/19 16:07
6	71	(mounting adj structure) and rhomb\$3	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/19 16:08
7	2	(mounting adj structure) and rhomb\$3 near4 (substrate or layer)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/19 16:19
8	12	LED and rhomb\$3 near4 (substrate or layer)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/19 16:10
9	5393	(mounting adj structure) and (LED or semiconduct\$3)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/19 16:18
10	2	((mounting adj structure) and (LED or semiconduct\$3)) and rhomb\$3 near4 (substrate or layer)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/19 16:19
11	972	313/500, 510.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/19 16:23
12	2	(313/500, 510.ccls.) and rhombus	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/19 16:20
13	84	40/451.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/19 16:24
14	0	40/451.ccls. and rhombus	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/19 16:24
15	1	345/36,34,33,39,40.ccls. and rhombus	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/19 16:26

18	0	362/238,250.ccls. and rhombus	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/08/19 16:26
19	556	(substrate or rhomb\$3) near4 rhomb\$3	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/08/19 16:28